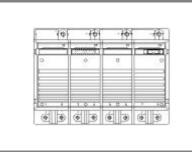
SKiiP 132GDL120-412CTV



SKiiP[®]2

7-pack - integrated intelligent Power System

Power section - brake chopper

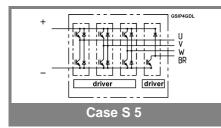
SKiiP 132GDL120-412CTV

Features

- SKiiP technology inside
- Low loss IGBTs
- CAL diode technology
- Integrated current sensor
- Integrated temperature sensor
- Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP[®] 2 System)
- IEC 68T.1 (climate) 40/125/56 (SKiiP[®] 2 power section)
- UL recognized File no. E63532 (SKiiP[®] 2 power section)
- with assembly of suitable MKP capacitor per terminal (SEMIKRON type is recommended)

Absolute	Maximum Ratings	r_s = 25 °C unless otherwise specified				
Symbol	Conditions	Values	Units			
IGBT						
V _{CES}		1200	V			
V _{CC} ¹⁾	Operating DC link voltage	900	V			
V _{GES}		± 20	V			
I _C	T _s = 25 (70) °C	150 (112,5)	А			
Inverse diode						
I _F = - I _C	T _s = 25 (70) °C	150 (112,5)	А			
I _{FSM}	$T_{j} = 150 \text{ °C}, t_{p} = 10 \text{ ms}; \text{ sin.}$	1440	A			
I²t (Diode)	Diode, T _j = 150 °C, 10 ms	10	kA²s			
T _j , (T _{stg})		- 40 (- 25) + 150 (125)	°C			
V _{isol}	AC, 1 min. (mainterminals to heat sink)	3000	V			

Characteristics T _s = 25 °C unless otherwise specie							specified		
Symbol	I Conditions			min.	typ.	max.	Units		
IGBT									
V _{CEsat}	I _C = 125 A	λ, Τ _j = 25 (1	25) °C			2,6 (3,1)		V	
V _{CEO}	T _j = 25 (12						1,5 (1,6)	V	
r _{CE}	$T_{j} = 25 (12)$						12,6 (16,1)	mΩ	
I _{CES}	V _{GE} = 0 V	, V _{CE} = V _{CE}	ES,			(10)	0,4	mA	
	T _j = 25 (12								
E _{on} + E _{off}	I _C = 125 A	, V _{CC} = 60	0 V				38	mJ	
	T _j = 125 °	C, V _{CC} = 90	V 00				66	mJ	
R _{CC' + EE'}	terminal chip, T _i = 125 °C					0,5		mΩ	
L _{CE}	top, bottor	n				15		nH	
C _{CHC}	per phase	, AC-side				1,4		nF	
Inverse o	Inverse diode								
$V_F = V_{EC}$	I _F = 150 A	., T _i = 25 (1	25) °C			2,1 (1,9)	2,6	V	
	T _i = 25 (12	25) °C				1,3 (1)	1,4 (1,1)	V	
r _T	T _j = 25 (12	25) °C				5 (6)	6,8 (7,8)	mΩ	
E _{rr}		, V _{CC} = 60					6	mJ	
	T _j = 125 °	C, V _{CC} = 90	00 V				8	mJ	
Mechani	cal data								
M _{dc}		als, SI Unit			6		8	Nm	
M _{ac}		als, SI Unit			13		15	Nm	
w	SKiiP [®] 2 System w/o heat sink					3,5		kg	
w	heat sink					8,5		kg	
			P16 hea	t sink; 27	75 m ³ /h)	; " _, " refe	rence to		
temperat		sor							
R _{th(j-s)I}	per IGBT						0,18	K/W	
R _{th(j-s)D}	per diode						0,375	K/W	
$R_{th(s-a)}$	per modul						0,036	K/W	
Z _{th}	R _i (mK/W) (max. values)				tau _i (s)				
	1	2	3	4	1	2	3	4	
Z _{th(j-r)I}	20	139	22		1	0,13	0,001		
Z _{th(j-r)D}	41	289	45		1	0,13	0,001		
Z _{th(r-a)}	1,7	24	7,6	2,6	494	165	20	0,03	



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SKiiP 132GDL120-412CTV



SKiiP[®] 2

7-pack - integrated intelligent Power System

7-pack gate driver - brake chopper

SKiiP 132GDL120-412CTV

Gate driver features

- CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and DC-bus voltage (option)
- Short circuit protection
- Over current protection
- Over voltage protection (option)Power supply protected against
- under voltage
- Interlock of top/bottom switch
- · Isolation by transformers
- Fibre optic interface (option for GB-types only)
- IEC 68T.1 (climate) 25/85/56 (SKiiP[®] 2 gate driver)

Absolute Maximum Ratings					
Symbol	Conditions	Values	Units		
V _{S1}	stabilized 15 V power supply	18	V		
V _{S2}	unstabilized 24 V power supply	30	V		
V _{iH}	input signal voltage (high)	15 + 0,3	V		
dv/dt	secondary to primary side	75	kV/µs		
V _{isollO}	input / output (AC, r.m.s., 2s)	3000	Vac		
V _{isol12}	output 1 / output 2 (AC, r.m.s., 2s)	1500	Vac		
f _{max}	switching frequency	5	kHz		
T _{op} (T _{stg})	operating / storage temperature	- 25 + 85	°C		

Characteristics (T _a :					= 25 °C)
Symbol	Conditions	min.	typ.	max.	Units
V _{S1}	supply voltage stabilized	14,4	15	15,6	V
V _{S2}	supply voltage non stabilized	20	24	30	V
I _{S1}	V _{S1} = 15 V	67+10	67+10*f/f _{max} +0,0*(I _{AC} /A)		
I _{S2}	V _{S2} = 24 V	67+10'	67+10*f/f _{max} +0,0*(I _{AC} /A)		
V _{iT+}	input threshold voltage (High)	11,2			V
V _{iT-}	input threshold voltage (Low)			5,4	V
R _{IN}	input resistance		10		kΩ
t _{d(on)IO} t _{d(off)IO} t _{pERRRESET}	input-output turn-on propagation time input-output turn-off propagation time error memory reset time top / bottom switch : interlock time	300000	20,2 25,6		μs μs μs μs
t _{TD} I _{analogOUT} I _{Vs1outmax} I _{A0max} V _{0I} V _{0H}	8 V corresponds to max. current of 15 V supply voltage (available when supplied with 24 V) output current at pin logic low output voltage logic high output voltage			0,6 30	A mA mA V V
I _{TRIPSC} I _{TRIPLG} T _{tp} U _{DCTRIP}	over current trip level (I _{analog OUT} = 10 V) ground fault protection over temperature protection trip level of U _{DC} -protection (U _{analog OUT} = 9 V); (option)	110		120	A A °C V

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